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June 14, 2004

Commissioner for Patents
P.O.Box 1450

Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572 28 Davis Avenue Poughkeepsie, N.Y. 12603

Subject:

| Serial No. 10/828,887 04/21/04 |

Yisuo Li et al.

SHALLOW LOW ENERGY ION IMPLANTATION INTO PAD OXIDE FOR IMPROVING THRESHOLD VOLTAGE STABILITY

## INFORMATION DISCLOSURE STATEMENT

Enclosed is Form PTO-1449, Information Disclosure Citation In An Application.

The following Patents and/or Publications are submitted to comply with the duty of disclosure under CFR 1.97-1.99 and 37 CFR 1.56.

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on June (), 2004.

Stephen B. Ackerman, Reg.# 37761

Signature/Date

CS-03-028

- U.S. Patent 4,154,626 to Joy et al., "Process of Making Field Effect Transistor Having Improved Threshold Stability by Ion-Implantation," describes a process of making an FET device with improved threshold stability by ion implantation.
- U.S. Patent 6,177,333 to Rhodes, "Method for Making a Trench Isolation for Semiconductor Devices," describes a method for making trench isolations in semiconductor devices.
- U.S. Patent Application Publication US 2002/0179997 A1 to Goth et al., "Self-Aligned Corner Vt Enhancement with Isolation Channel Stop by Ion Implantation," describes a process of fabricating an FET device using a simultaneous implantation of the well species at the edge of the device and at the bottom of the shallow trench isolation regions.
- U.S. Patent Application Publication US 2001/0021545 A1 to Houlihan et al., "Method for Eliminating Transfer Gate Sacrificial Oxide," describes a method for eliminating the transfer gate sacrificial oxide.

Sincerely,

Stephen B. Ackerman,

Reg. No. 37761